

# LNPTM STAT-LOYTM COMPOUND D3000I

## DESCRIPTION

LNP STAT-LOY D3000I compound is a Polycarbonate (PC) resin based electrically conductive material with colorability, low surface resistivity, high HDT, low temperature impact toughness and good surface quality. This material is targeted for explosive proof application.

| GENERAL INFORMATION   |   |
|-----------------------|---|
| Features              | Antistatic, Impact resistant, No PFAS intentionally added |
| Fillers               | Unreinforced  |
| Polymer Types         | Polycarbonate (PC)  |
| Processing Techniques | Injection Molding   |

| INDUSTRY                   | SUB INDUSTRY          |
|----------------------------|-----------------------|
| Electrical and Electronics | Electronic Components |

## TYPICAL PROPERTY VALUES

Revision 20240716

| PROPERTIES                                 | TYPICAL VALUES | UNITS             | TEST METHODS |
|--|----------------|-------------------|--------------|
| <b>MECHANICAL <sup>(1)</sup></b>           |                |                   |              |
| Tensile Stress, brk, Type I, 50 mm/min     | 46.7           | MPa               | ASTM D638    |
| Tensile Strain, brk, Type I, 50 mm/min     | 83.59          | %                 | ASTM D638    |
| Tensile Modulus, 50 mm/min                 | 1888           | MPa               | ASTM D638    |
| Flexural Strength, 1.3 mm/min, 50 mm span  | 70.1           | MPa               | ASTM D790    |
| Flexural Modulus, 1.3 mm/min, 50 mm span   | 1730           | MPa               | ASTM D790    |
| Tensile Stress, break, 50 mm/min           | 44.2           | MPa               | ISO 527      |
| Tensile Strain, break, 50 mm/min           | 81.28          | %                 | ISO 527      |
| Tensile Modulus, 1 mm/min                  | 1873           | MPa               | ISO 527      |
| Flexural Strength, 2 mm/min                | 71.2           | MPa               | ISO 178      |
| Flexural Modulus, 2 mm/min                 | 1862           | MPa               | ISO 178      |
| <b>IMPACT <sup>(1)</sup></b>               |                |                   |              |
| <b>Izod Impact</b>                         |                |                   |              |
| notched, 23°C                              | 669            | J/m               | ASTM D256    |
| unnotched, 23°C                            | NB             | J/m               | ASTM D4812   |
| notched, -30°C                             | 505            | J/m               | ASTM D256    |
| unnotched, -30°C                           | NB             | J/m               | ASTM D4812   |
| notched, -40°C                             | 237            | J/m               | ASTM D256    |
| unnotched, -40°C                           | NB             | J/m               | ASTM D4812   |
| Izod Impact, notched 80*10*4 +23°C         | 65.21          | kJ/m <sup>2</sup> | ISO 180/1A   |
| Izod Impact, unnotched 80*10*4 +23°C       | NB             | kJ/m <sup>2</sup> | ISO 180/1U   |
| Charpy 23°C, V-notch Edgew 80*10*4 sp=62mm | 60.58          | kJ/m <sup>2</sup> | ISO 179/1eA  |
| Charpy 23°C, Unnotch Edgew 80*10*4 sp=62mm | NB             | kJ/m <sup>2</sup> | ISO 179/1eU  |
| <b>THERMAL <sup>(1)</sup></b>              |                |                   |              |
| HDT, 0.45 MPa, 3.2 mm, unannealed          | 121            | °C                | ASTM D648    |

| PROPERTIES                              | TYPICAL VALUES | UNITS    | TEST METHODS      |
|---|----------------|----------|-------------------|
| HDT, 1.82 MPa, 3.2mm, unannealed        | 105            | °C       | ASTM D648         |
| HDT, 0.45 MPa, 6.4 mm, unannealed       | 124            | °C       | ASTM D648         |
| HDT, 1.82 MPa, 6.4 mm, unannealed       | 115            | °C       | ASTM D648         |
| HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm  | 121            | °C       | ISO 75/Bf         |
| HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm   | 100            | °C       | ISO 75/Af         |
| <b>CTE</b>                              |                |          |                   |
| -40°C to 80°C, flow                     | 8.1E-5         | 1/°C     | ASTM E831         |
| -40°C to 80°C, xflow                    | 9.9E-5         | 1/°C     | ASTM E831         |
| -40°C to 80°C, flow                     | 7.8E-5         | 1/°C     | ISO 11359-2       |
| -40°C to 80°C, xflow                    | 1.0E-4         | 1/°C     | ISO 11359-2       |
| Vicat Softening Temp, Rate B/120        | 121            | °C       | ASTM D1525        |
| Vicat Softening Temp, Rate B/120        | 120            | °C       | ISO 306           |
| <b>PHYSICAL <sup>(1)</sup></b>          |                |          |                   |
| Specific Gravity                        | 1.18           | -        | ASTM D792         |
| Melt Flow Rate, 260°C/1.2 kgf           | 13.7           | g/10 min | ASTM D1238        |
| Moisture Absorption (23°C / 50% RH)     | 0.14           | %        | ISO 62            |
| Mold Shrinkage, flow <sup>(2)</sup>     | 0.73           | %        | SABIC method      |
| Mold Shrinkage, xflow <sup>(2)</sup>    | 0.93           | %        | SABIC method      |
| <b>ELECTRICAL <sup>(1)</sup></b>        |                |          |                   |
| Surface Resistivity                     | 4.4E+10        | Ω        | ASTM D257         |
| Volume Resistivity                      | 1.3E+11        | Ω.cm     | ASTM D257         |
| Surface Resistivity                     | 5.0E+9         | Ω        | ANSI/ESD STM11.13 |
| Dielectric Constant, 1.1 GHz            | 3.02           | -        | SABIC method      |
| Dissipation Factor, 1.1 GHz             | 0.03358        | -        | SABIC method      |
| Dielectric Constant, 1.9 GHz            | 2.96           | -        | SABIC method      |
| Dissipation Factor, 1.9 GHz             | 0.03144        | -        | SABIC method      |
| Dielectric Constant, 5 GHz              | 2.93           | -        | SABIC method      |
| Dissipation Factor, 5 GHz               | 0.02694        | -        | SABIC method      |
| Dielectric Constant, 10 GHz             | 2.95           | -        | SABIC method      |
| Dissipation Factor, 10 GHz              | 0.02242        | -        | SABIC method      |
| Dielectric Constant, 20 GHz             | 2.77           | -        | SABIC method      |
| Dissipation Factor, 20 GHz              | 0.02251        | -        | SABIC method      |
| <b>INJECTION MOLDING <sup>(3)</sup></b> |                |          |                   |
| Drying Temperature                      | 75 – 80        | °C       |                   |
| Drying Time                             | 6 – 8          | Hrs      |                   |
| Melt Temperature                        | 240 – 260      | °C       |                   |
| Nozzle Temperature                      | 240 – 260      | °C       |                   |
| Front - Zone 3 Temperature              | 240 – 260      | °C       |                   |
| Middle - Zone 2 Temperature             | 240 – 260      | °C       |                   |
| Rear - Zone 1 Temperature               | 240 – 260      | °C       |                   |
| Mold Temperature                        | 40 – 60        | °C       |                   |

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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